

3.0mmx1.0 mm RIGHT ANGLE INFRARED **EMITTING DIODE**

Part Number: KPA-3010F3C

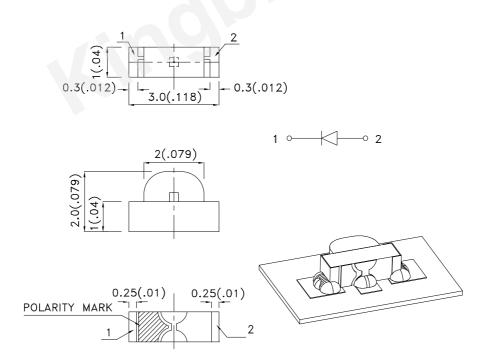
Features

- 3.0mmx1.0mm right angle SMT LED, 2.0mm thickness.
- Mechanically and spectrally matched to phototransistor.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4.The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPA-3010F3C	F3 (GaAs)	Water Clear	1.2	3	- 120°
			*0.8	*2	

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions
Forward Voltage [1]	F3	VF	1.2	1.6	V	IF=20mA
Reverse Current	F3	lr		10	uA	V _R = 5V
Capacitance	F3	С	90		pF	VF=0V;f=1MHz
Peak Spectral Wavelength	F3	λP	940		nm	IF=20mA
Spectral Bandwidth	F3	Δλ1/2	50		nm	IF=20mA

Notes:

1.Forward Voltage: +/-0.1V.

2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

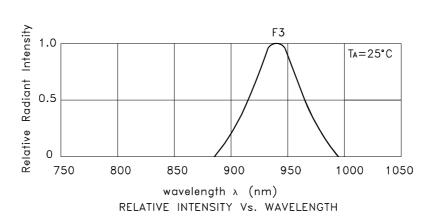
Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	F3	Units			
Power dissipation	PD	80	mW			
DC Forward Current	lF	50	mA			
Peak Forward Current [1]	iFS	1.2	Α			
Reverse Voltage	VR	5	V			
Operating Temperature	ТА	-40 To +85	°C			
Storage Temperature	Тѕтс	-40 To +85	°C			

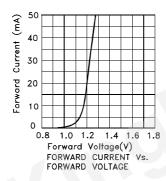
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

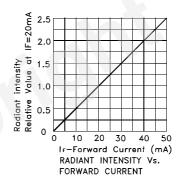
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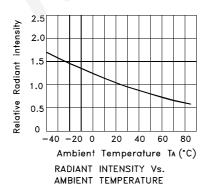
^{2.} Radiant Intensity/ luminous flux: +/-15%.
*Radiant Intensity value is traceable to the CIE127-2007 compliant national standards.

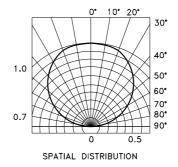


KPA-3010F3C







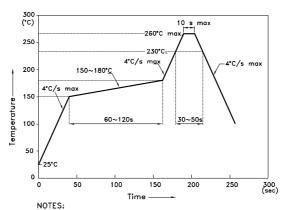


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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



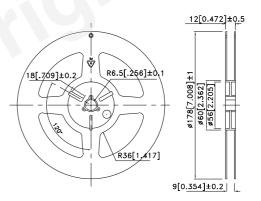
- 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

 3.Number of reflow process shall be 2 times or less.

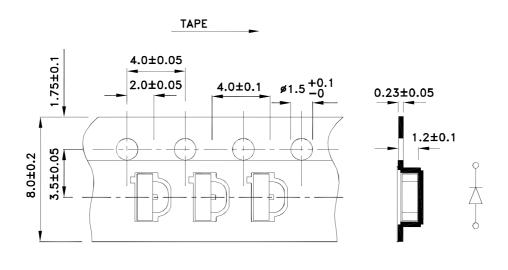
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

0.9

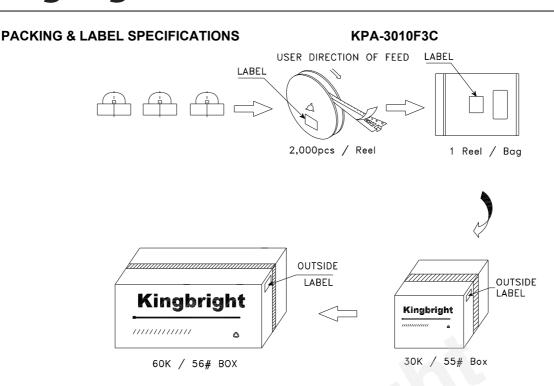
Reel Dimension

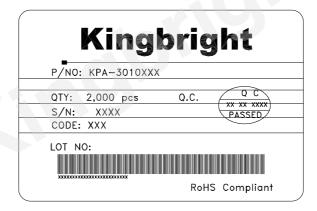


Tape Specifications (Units: mm)



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6.Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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